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SUBMISSION TYPE:		NEW ASSIGNMENT					
NATURE OF CONVE	YANCE:	ASSIGNMENT	ASSIGNMENT				
CONVEYING PARTY	' DATA						
		Name	Execution Date				
Yoko KITAHARA			11/13/2008				
Fumihisa MIZUOCHI		11/13/2008					
Takuma HIGO		11/14/2008					
Takaharu FUJII		11/13/2008					
Masaru KATAOKA		11/13/2008					
Nobuo OZAWA			11/13/2008				
Tatsuya YAMAZAKI			11/27/2008				
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City:	Токуо						
State/Country:	JAPAN						
Postal Code:	108-0075						
	RS Total: 1						
Property T	уре	Num	ber				
Application Number:		12241501	501				
CORRESPONDENC	E DATA						
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ATTORNEY DOCKET	NUMBER:	332462US8					
			PATENT				
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Total Attachments: 2

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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of cortain new and useful improvements in VEHICLE-MOUNTED DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, 108-0075 Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these prosents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents rolating to said application, said invention and said Letters Patent and legal equivalents in forcign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Scrial Number: 12/241,501 Filing Date: September 30, 2008

This assignment executed on the dates indicated below.

Yoko KITAHARA							
Name	of	first	or	sole	inventor		

Execution date of U.S. Patent Application

Tokyo, Japan Residence of first or sole inventor

TK F. B. J Signature of first or sole inventor

November 13 2008 Date of this assignment

PATENT REEL: 021977 FRAME: 0072

Fumihisa MIZUOCHI	
Name of second inventor	Execution date of U.S. Patent Application
Saitama, Japan	
Residence of second inventor	
水落文之	November 13, 2008
<u>>K 落 文え</u> Signature of second inventor	November 13, 2008 Date of this assignment
Takuma HIGO Name of third inventor	Execution date of U.S. Patcnt Application
Mane of third inventor	Execution date of 0.5. I admit Application
Tokyo, Japan	
Residence of third inventor	
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A巴後 琢磨 Signature of third inventor	November 4,2008 Date of this assignment
Signature of third inventor	Date of this assignment
	:
Takaharu FUJII	
Name of fourth inventor	Execution date of U.S. Patent Application
Saitama, Japan Residence of fourth inventor	· · · · · · · · · · · · · · · · · · ·
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藤井亭方	Noue 13 2008
藤井 崇 玄 Signature of fourth inventor	November 13, 2008 Date of this assignment
Masaru KATAOKA	
Name of fifth inventor	Execution date of U.S. Patent Application
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「「」大 Signature of fifth inventor	November 13, 2008 Date of this assignment
Signature of fifth inventor	Date of this assignment
Nobuo OZAWA	
Name of sixth inventor	Execution date of U.S. Patent Application
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Kanagawa, Japan Residence of sixth inventor	
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和泽东来	Nov 13 2000
Signature of sixth inventor	Nov. 13. 2008 Date of this assignment
Tatsuya YAMAZAKI Name of seventh inventor	There is a contract of the con
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Residence of seventh inventor	
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山崎連也	Nov. 27, 2008 Date of this assignment
Signature of seventh inventor	Date of this assignment

RECORDED: 12/10/2008

PATENT REEL: 021977 FRAME: 0073